5th PCNS Seville, Spain 9-12th September 2025

PRELIMINARY PROGRAM

Program subjected to change Ver.1.1.

Tuesday 9th September 2025 Workshop & CNA Tour

13:00-14:00 Workshop I. Passive Components Technologies Update; Design Review of EMI filter for Power Electronics – How Components Influence the Performance; Speaker: Frank Puhane, Würth Elektronik eiSos GmbH & Co. KG

---- break ----

14:30-15:50 Workshop II. Key Aspects of Selection, Procurement, and Testing of Passive EEE Components for Harsh Environment Applications; ALTER TECHNOLOGY; Speaker: Manuel Sánchez, ALTER Technology, EEE Parts Engineer

---- break ----

16:10-17:30 Centro Nacional de Aceleradores tour; Tour through university accelerator centre (registration required, no fee)

Wednesday 10th September 2025 Conference & Networking

9:00-9:30 Welcome University of Seville, ALTER TECHNOLOGY and EPCI

9:30-9:55 Keynote I. European Passive Components Market; EPCIA European Passive Components Industry Association Speaker: Luca Primavesi; Itelcond president and EPCIA member

9:55-10:00 EPCIA Student Awards Ceremony; EPCIA

10:00-10:30 Speakers Introduction

---- break ----

- 11:00-12:00 TPI Technical Product Introduction Flash Presentations 5min short commercial presentations from manufacturers to introduce its hot product / news or invitations to exhibition booth
- 12:00-12:30 Keynote II Quality Challenges and Risk Mitigation for Passive Components in Harsh Environments; Speaker: Antonio Rodriguez Arenas, ALTER TECHNOLOGY

------ FINGER PICK LUNCH AT EXHIBITION FLOOR ------

13:20-14:35 Session I. HARSH APPLICATIONS; Chairman:

- 1.1. Thermoset Polymer Dielectric Capacitors for Harsh Environment Applications; Angelo Yializis; Polycharge Inc.; USA
- 1.2. Tantalum Capacitors Technologies for Harsh Environments; Michel Bouvier; Vishay Tantalum Division; France
- 1.3. Murata's Silicon Capacitors: Reliable Performance in Extreme Conditions; Enzo Darcy; Murata Europe; France

---- break ----

15:05-15:35 Keynote III. Advances in the Environmental Performance of Polymer Capacitors; Philip Lessner; Philip Lessner Consulting; USA

15:35-17:15 Session II. QUALITY & RELIABILITY; Chairman:

- 2.1. Enhancing E-Textile Reliability: A Comparative Study of SMD-Ribbon Joints Protections Against Sweat; Martin Hirman; University of West Bohemia, Pilsen, Czech Republic
- 2.2. New Generation of Metallized Film Capacitors Based on EPN for Solving Upcoming High Temperature and High Power Density Requirements; Manuel Gómez; TDK Malaga, Spain
- 2.3. Protecting the Quality & Reliability of Passive (and Active) Components: the J-STD-075 PSL Classification & Labeling; Arnaud Grivon; Thales Global Services, Meudon, France
- 2.4. Lifetime Assessment for Capacitors in EPS Application; Krzysztof Ptak; Nexteer Automotive, Poland

---- break ----

17:35-19:15 Session II. QUALITY & RELIABILITY (cont.); Chairman:

- 2.5. Development and Validation of the New IRCA S.p.A.'s Pure-Polyimide Flexible Heater for High-Reliability and High-Performance Markets; Alessandra Marcer; IRCA s.p.a. Zoppas Industries; Italy
- 2.6. Assessment of a Graphene-Based Supercapacitor: Environmental Hotspots and End-of-Life Strategies for Sustainable Energy Storage; Gianmarco Gottardo; Politecnico di Milano, Italy
- 2.7. Capacitor Degradation and Failure Mechanisms: Exploring Different Causes Across Technologies; Frank Puhane; Würth Elektronik eiSos GmbH & Co. KG; Germany
- 2.8. Beyond 85/85: Towards Realistic Lifetime Estimation of Polypropylene Film Capacitors in Humid Environments; Massimo Totaro; KEMET YAGEO Group; Italy

Thursday 11th September 2025 Panel Discussion & Sessions

9:00-10:30 Special Session. AI and its Consequences; Chairman: Tomas Zednicek, EPCI

AI.1 Revolutionizing the Defect Detention during the Cross-Sectional analysis for Electronics with Computer Vision; Mari Carmen López López; ALTER TECHNOLOGY, Spain

Al.2 Passive Components in Al Systems; Slavomír Pala; KYOCERA AVX, Lanskroun, Czech Republic

AI.3 AI Hardware Development and Its Consequences for Passive Electronic Components; Tomas Zednicek; EPCI; Czech Republic

---- break ----

11:00-12:30 Hot Topic Panel Discussion: AI and its Consequences to Passive Components

Panellists: passive component manufacturers & end users experts

------ lunch ------

13:20-13:50 Keynote IV. Space Evaluation Testing on SAW Filter Based on POI Technology); Kaoutar Zeljami; ALTER TECHNOLOGY, Spain

13:50-15:30 Session III. NEW DEVELOPMENT; Chairman:

- 3.1 Textile-Based Antennas; Tomas Blecha; University of West Bohemia, Pilsen, Czech Republic
- 3.2 New Construction and Packaging Process for Highest Voltage Aluminium Polymer Electrolytic Capacitor; Tim Kruse, PhD student; Syddansk Universitet Sønderborg; Denmark
- 3.3 A New Approach to the Design of High Precision Integrated Resistive Voltage Dividers; Stephen Oxley; TT Electronics; UK
- 3.4 Revolutionizing High Frequency Applications: 3-Terminal XG3 Eulex Gap Capacitor; Colin McClennan; Quantic Eulex; USA

---- break ----

16:00-17:40 Session IV. MATERIALS & PROCESSES; Chairman:

- **4.1** Flaked Tantalum Powders: High Capacitance Powders for High Reliable Tantalum Capacitors; Gordon Smith; Global Advanced Metals; USA
- **4.2** Reliability of E-Textile Conductive Paths and Passive Component Interfaces; Julie Hladikova; University of West Bohemia, Pilsen, Czech Republic
- 4.3 Layer-by-Layer Fabrication of Thin Polypropylene-based Dielectrics; Bartosz Gackowski; CIE, SDU; Denmark
- **4.4** Development and Prototyping of Nitrogen-Doped Graphene Supercapacitors; Veronika Šedajová; Palacký University Olomouc, Czech Republic

---- move by walk to ALTER TECHNOLOGY facility ----

18:00-19:30 --- ALTER TECHNOLOGY Test Facility Tour (bus coach to Gala Dinner leaves ALTER TECHNOLOGY at 19:30) --------

20:00-23:00 ------ Murata Gala Dinner (individual leave from Gala Dinner restaurant in the city center) ------

Friday 12th September 2025 **Sessions & Closing**

9:00-10:40 Session V. APPLICATIONS; Chairman:

- **4.1.** High-Performance Component Strategies to Address Thermal and Frequency Challenges in Base Stations; Che Wei Hsu; Murata Europe; Netherlands
- 4.2. Automotive Polymer Tantalum Capacitors with capabilities beyond AEC-Q200 Guidelines for usage on LEO Satellite Industry; Cristina Caetano; KEMET, a YAGEO Company, Portugal
- 4.3. Improving Switched-Mode Power Supplies Performance with Modified Thermal Interface Material; Victor Solera; University of Valencia; Spain
- 4.4. Resonant Capacitors in High-Power Resonant Circuits; Moaz ElGhazali; Murata Europe; Germany

---- break ----

11:10-12:50 Session V. DESIGN & CONSTRUCTION; Chairman:

- 5.1. Qualification of Commercial Off-The-Shelf Supercapacitors; David Latif; EGGO Space, Lanskroun; Czech Republic
- 5.2. Experimental Evaluation of Wear Failures in SMD Inductors; Masaaki Tsujii; Murata Manufacturing Co., Ltd.; Japan
- 5.3. How to Manage Leakage Current and Self Discharge of EDLC Capacitors; Gerald Tatschl; Vishay; Austria
- 5.4. Advancements in Flexible End Terminations for High-Reliability Passive Components in Electrified Vehicles; Dean Buzby; Heraeus Electronics; USA

12:50-13:00 Best Paper Awards & Closing Ceremony

------ 13:00 lunch -----